

INVITATION OF SEALED BIDS

Siddhartha Bank invites sealed bids from firms/companies for **"Supply/Delivery of Dual Interface EMV Chip Cards."**

Published Date : 11 October 2023 (Karobar National Daily)
Bid Ref No : SBL/BID/80-81/05
Bid Document Fee : NPR 1,000
Bid Security Amount : NPR 100,000 with 3 months validity
Submission Deadline : 30 October 2023, Within 5 PM
Submission Place : General Administration Department at Hattisar,
Kathmandu

Minimum Eligibility/Criteria:

- a. The proposed chip should be certified from the NEPS switching System.
- b. The Bidder should be Original Equipment Manufacturer (OEM) or their authorized distributor/system integrator.

The detailed scopes of work and terms & conditions can be found in the Request for Proposal (RFP) document. Eligible parties can obtain RFP document from the Bank's General Administration Department, Hattisar during office hours upon deposit of nonrefundable bid document fee

Note :

The Bank reserves the right to accept/reject any or all proposals with or without assigning any reasons whatsoever.



SiddharthaBank

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